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(54) Title: RFID ARRANGEMENT, PIECE OF JEWELRY, LOCAL SENDING ARRANGEMENT, AND METHODS

(57) Abstract: The invention relates to an RFID arrangement comprising an RFID tag and a housing at least partially enclosing the RFID tag, wherein the RFID tag has a first contact and a second contact, and wherein the first contact is electrically connected to the housing. The invention relates further to a corresponding piece of jewelry, to corresponding methods, and to a corresponding local sending arrangement.

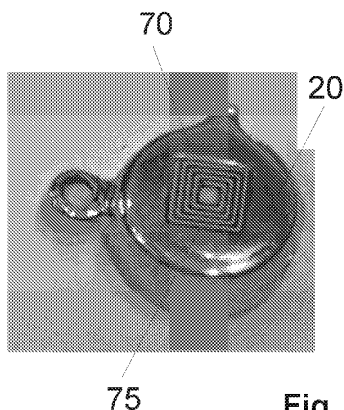


Fig. 11

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